

NDS Compliant

TECHNICAL CHARACTERISTICS

1. General Characteristics

Dimension: 27.55L x 18.70W x 1.90H mm
 Weight: Approx. 1.38 g
 Contact principle: Friction technology
 Operating position: Shaft up / Down / Horizontal
 Mounting System: SMT Type (post optional)
 Function: Push Push Type
 Durability: 5,000 cycles min.

2. Mechanical Characteristics

Insulation material: Thermoplastic, UL 94V-0
 RoHS Directive 2002/95/EC Compliant

3. Electrical Characteristics

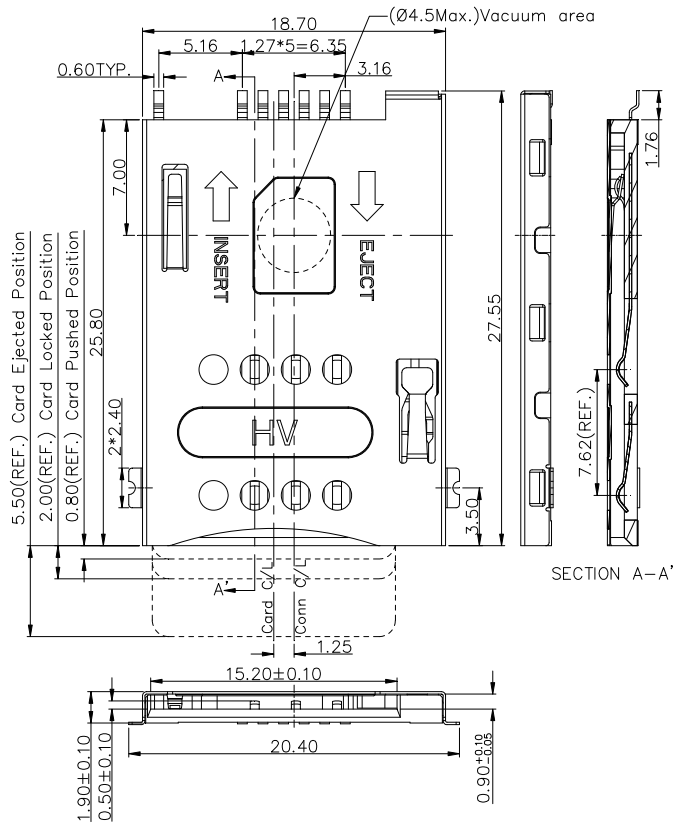
Number of contacts: 6, 8 pins (optional)
 Contact resistance: 50 mΩ typical, 100 mΩ max.
 Insulation resistance: >1000 MΩ / 500 VDC
 Switch type: Blade
 Operation: Normally Close

4. Solderability

Wave: Not applicable
 IR reflow: 260°C, 10 sec. Max.
 Manual soldering: 360°C, 3 sec. Max.

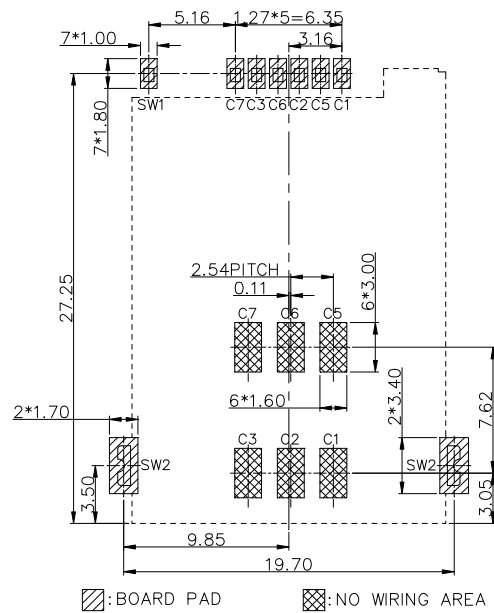
5. Environmental Characteristics

Operating temperature: - 40°C ~ + 85°C
 Operating humidity: 10 % ~ 95 % RH
 Storage temperature: - 40°C ~ + 85°C
 Storage humidity: 10 % ~ 95 % RH



※Must keep minimum 0.2mm gap above connector to assure the push function in good condition.

Unit: mm; Tolerances: ±0.15 mm
Mechanical outline dimension



Unit: mm; Tolerances: ±0.05 mm
Reference dimension for PCB layout

H&V SIM Card Acceptor

Model No.: ICA-568 Type1 6Pin

Revision: 1.0

Date: JAN. 01, 2011